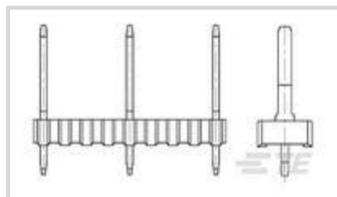




Connectors &gt; PCB Connectors &gt; PCB Headers &amp; Receptacles

PCB Connector Assembly Type: **PCB Mount Header**PCB Mount Orientation: **Vertical**Connector System: **Board-to-Board**Number of Positions: **3**Number of Rows: **1**

## Features

### Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Unshrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

### Configuration Features

Connector Contact Load Condition	Selectively Loaded
PCB Mount Orientation	Vertical
Number of Positions	3
Number of Rows	1
Board-to-Board Configuration	Parallel

### Body Features

Connector Profile	Standard
Primary Product Color	Green

### Contact Features

Contact Mating Area Length	10 mm[.394 in]
PCB Contact Termination Area Plating Material Thickness	2.5 – 5 $\mu$ m
Mating Tab Width	1.6 mm[.063 in]



Mating Tab Thickness	.8 mm[.031 in]
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Contact Underplating Material	Nickel
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Contact Base Material	Copper Zinc
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Contact Mating Area Plating Material	Gold
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Contact Mating Area Plating Material Thickness	.8 μm[31.5 μin]
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Contact Type	Pin
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Contact Current Rating (Max)	5 A
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### Termination Features

Rectangular Termination Post & Tail Thickness	.8 mm[.031 in]
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Rectangular Termination Post & Tail Width	.9 mm[.035 in]
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Termination Post & Tail Length	3.4 mm[.134 in]
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Termination Method to Printed Circuit Board	Through Hole - Solder
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### Mechanical Attachment

Mating Alignment	Without
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PCB Mount Retention	Without
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Connector Mounting Type	Board Mount
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### Housing Features

Centerline (Pitch)	10.16 mm[.4 in]
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Housing Material	PBTP
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### Dimensions

PCB Thickness (Recommended)	1.6 mm[.063 in]
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### Usage Conditions

Housing Temperature Rating	Standard
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Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
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### Operation/Application

Solder Process Feature	Board Standoff
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### Industry Standards

UL Flammability Rating	UL 94V-0
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### Packaging Features

Packaging Quantity	200
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Packaging Type	Box, Carton
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### Other



Position Locations Omitted	2, 3, 4
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### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Compatible Parts



Also in the Series | [AMPMODU MOD 1](#)



Automotive Terminals(6)

Board-to-Board Connector Contacts  
(104)

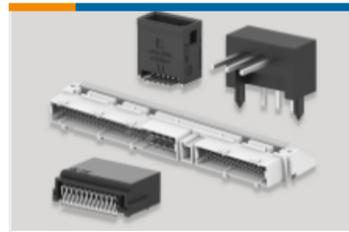
Board-to-Board Jumpers &amp; Shunts(5)



Insertion &amp; Extraction Tools(1)



PCB Connector Keying(2)



PCB Headers &amp; Receptacles(372)

Wire-to-Board Connector Assemblies  
& Housings(44)

Wire-to-Board Connector Contacts(2)

## Documents

### Product Drawings

#### MOD1 STIFTELEIS 3P

English

### Product Specifications

#### Product Specification

English